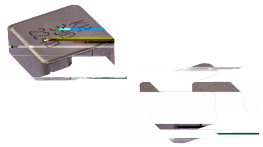
MDA Series

SMD Low Profile High Current Molded Inductor

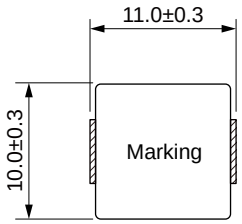
Size 1040

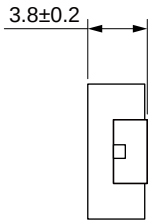


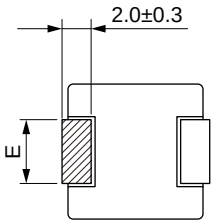
APPLICATION

-
- HVAC
-
- Audio subsystem
- Digital instrument cluster
-

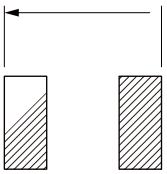
Dimensions: [mm]





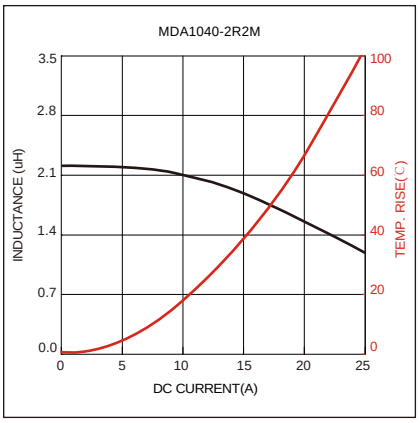


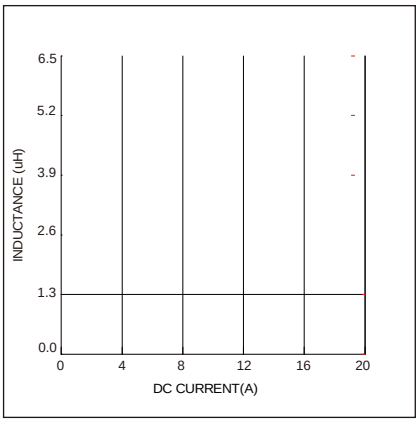
Land Pattern: [mm]

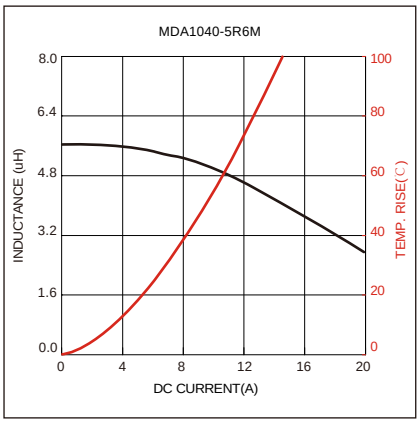


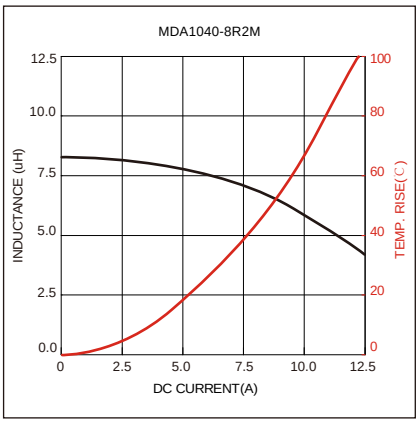
Electrical Properties:

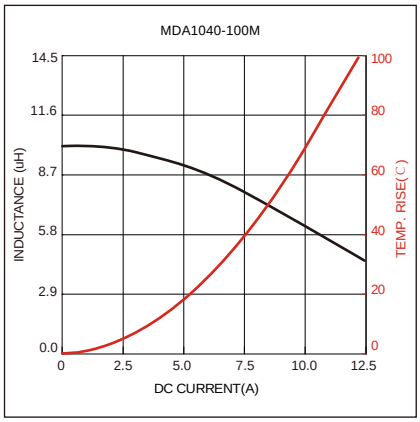
MDA1040-R15N	0.15	±30%	44.0	38.0	82.0	75.0	0.50	0.60	3.0±0.3
MDA1040-R22M	0.22	±20%	36.0	33.0	70.0	60.0	0.72	0.83	3.0±0.3
MDA1040-R36M	0.36	±20%	33.0	29.0	51.0	45.0	1.05	1.18	3.0±0.3
MDA1040-R47M	0.47	±20%	32.0	28.0	46.0	40.0	1.30	1.50	3.0±0.3
MDA1040-R56M	0.56	±20%	25.0	23.0	34.0	29.0	1.60	1.80	2.5±0.3
MDA1040-R68M	0.68	±20%	23.0	20.0	31.0	28.0	1.90	2.20	2.5±0.3
MDA1040-1R0M	1.00	±20%	20.0	18.0	29.0	26.0	2.90	3.25	2.5±0.3
MDA1040-1R5M	1.50	±20%	17.5	16.0	26.0	22.0	3.70	4.20	2.5±0.3
MDA1040-1R8M	1.80	±20%	16.5	15.0	23.0	20.0	5.10	5.70	3.0±0.3
MDA1040-2R2M	2.20	±20%	15.0	13.0	20.0	16.0	5.80	6.70	3.0±0.3
MDA1040-3R3M	3.30	±20%	11.0	10.0	17.5	14.0	10.5	11.8	3.0±0.3
MDA1040-4R7M	4.70	±20%	8.80	8.0	15.2	13.0	15.8	19.0	3.0±0.3
MDA1040-5R6M	5.60	±20%	8.00	7.2	14.1	11.5	19.0	22.8	3.0±0.3
MDA1040-6R8M	6.80	±20%	7.80	6.8	12.2	11.0	22.0	24.5	3.0±0.3


MDA1040-2R2M
INDUCTANCE (uH)
TEMP. RISE(℃)
DC CURRENT(A)
3.5
2.8
2.1
1.4
0.7
0.0
100
80
60
40
20
0
0
5
10
15
20
25

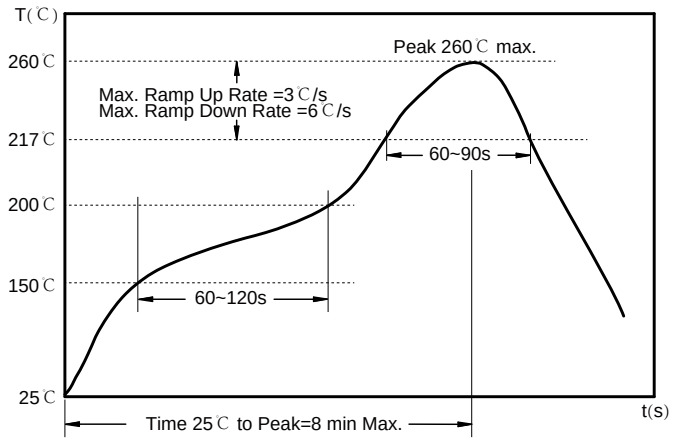

INDUCTANCE (uH)
DC CURRENT(A)
6.5
5.2
3.9
2.6
1.3
0.0
0
4
8
12
16
20


MDA1040-5R6M
INDUCTANCE (uH)
TEMP. RISE(℃)
DC CURRENT(A)
8.0
6.4
4.8
3.2
1.6
0.0
100
80
60
40
20
0
0
4
8
12
16
20


MDA1040-8R2M
INDUCTANCE (uH)
TEMP. RISE(℃)
DC CURRENT(A)
12.5
10.0
7.5
5.0
2.5
0.0
100
80
60
40
20
0
0
2.5
5.0
7.5
10.0
12.5


MDA1040-100M
INDUCTANCE (uH)
TEMP. RISE(℃)
DC CURRENT(A)
14.5
11.6
8.7
5.8
2.9
0.0
100
80
60
40
20
0
0
2.5
5.0
7.5
10.0
12.5

Soldering Reflow:



Preheat condition: 150 ~200℃/ 60~120 sec.

Allowed time above 217℃: 60~90 sec.

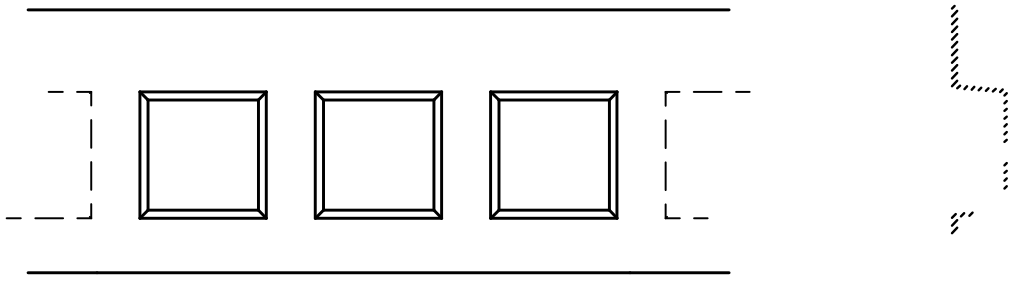
Max temperature: 260℃.

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

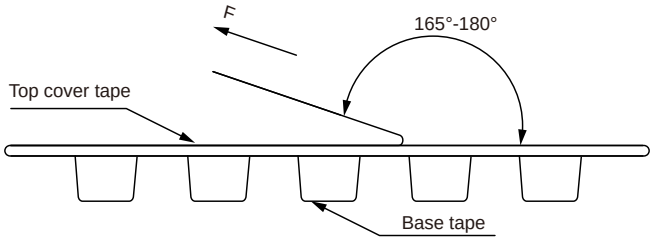
Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)A0
MDA1040	10.4±0.1	11.6±0.1	1.5±0.1	4.0±0.1	16.0±0.1	24.0±0.3	4.3±0.1	1.75±0.1	0.35±0.05

Peel force of top cover tape:

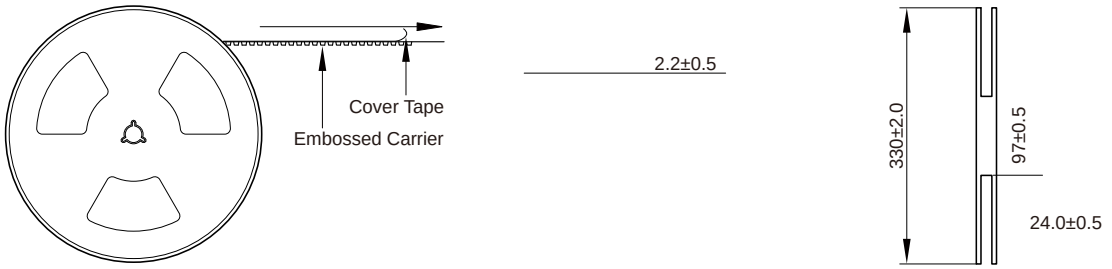


The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:

Marking	KH+Printing(Inductance+period)

Reel Dimension：[mm]



Packaging Quantity:



500 Pcs/Reel

2 Reel /Inner box(1000 Pcs)

3 Inner box/Carton box(3K Pcs)

Cautions and Warnings:

Storage Conditions：

Operation Instructions: